

### **General Description**

The MAX19505 dual-channel, analog-to-digital converter (ADC) provides 8-bit resolution and a maximum sample rate of 65Msps.

The MAX19505 analog input accepts a wide 0.4V to 1.4V input common-mode voltage range, allowing DCcoupled inputs for a wide range of RF, IF, and baseband front-end components. The MAX19505 provides excellent dynamic performance from baseband to high input frequencies beyond 400MHz, making the device ideal for zero-intermediate frequency (ZIF) and highintermediate frequency (IF) sampling applications. The typical signal-to-noise ratio (SNR) performance is 49.8dBFS and typical spurious-free dynamic range (SFDR) is 69dBc at  $f_{IN} = 70MHz$  and  $f_{CLK} = 65MHz$ .

The MAX19505 operates from a 1.8V supply. Additionally, an integrated, self-sensing voltage regulator allows operation from a 2.5V to 3.3V supply (AVDD). The digital output drivers operate on an independent supply voltage (OVDD) over the 1.8V to 3.5V range. The analog power consumption is only 43mW per channel at  $V_{AVDD} = 1.8V$ . In addition to low operating power, the MAX19505 consumes only 1mW in powerdown mode and 15mW in standby mode.

Various adjustments and feature selections are available through programmable registers that are accessed through the 3-wire serial-port interface. Alternatively, the serial-port interface can be disabled, with the three pins available to select output mode, data format, and clock-divider mode. Data outputs are available through a dual parallel CMOS-compatible output data bus that can also be configured as a single multiplexed parallel CMOS bus.

The MAX19505 is available in a small 7mm x 7mm 48-pin thin QFN package and is specified over the -40°C to +85°C extended temperature range.

Refer to the MAX19515, MAX19516, and MAX19517 data sheets for pin- and feature-compatible 10-bit, 65Msps, 100Msps, and 130Msps versions, respectively. Refer to the MAX19506 and MAX19507 data sheets for pin- and feature-compatible 8-bit, 100Msps and 130Msps versions, respectively.

### **Applications**

IF and Baseband Communications, Including Cellular Base Stations and Point-to-Point Microwave Receivers Ultrasound and Medical Imaging

Portable Instrumentation and Low-Power Data Acquisition

Digital Set-Top Boxes

### Features

- Very-Low-Power Operation (43mW/Channel at 65Msps)
- 1.8V or 2.5V to 3.3V Analog Supply
- Excellent Dynamic Performance 49.8dBFS SNR at 70MHz 69dBc SFDR at 70MHz
- ◆ User-Programmable Adjustments and Feature Selection through an SPI™ Interface
- Selectable Data Bus (Dual CMOS or Single Multiplexed CMOS)
- DCLK Output and Programmable Data Output Timing Simplifies High-Speed Digital Interface
- Very Wide Input Common-Mode Voltage Range (0.4V to 1.4V)
- Very High Analog Input Bandwidth (> 850MHz)
- Single-Ended or Differential Analog Inputs
- Single-Ended or Differential Clock Input
- Divide-by-One (DIV1), Divide-by-Two (DIV2), and Divide-by-Four (DIV4) Clock Modes
- Two's Complement, Gray Code, and Offset Binary Output Data Format
- Out-of-Range Indicator (DOR)
- CMOS Output Internal Termination Options (Programmable)
- Reversible Bit Order (Programmable)
- Data Output Test Patterns
- Small, 7mm x 7mm 48-Pin Thin QFN Package with Exposed Pad

### **Ordering Information**

| PART         | TEMP RANGE     | PIN-PACKAGE |
|--------------|----------------|-------------|
| MAX19505ETM+ | -40°C to +85°C | 48 TQFN-EP* |

+Denotes a lead(Pb)-free/RoHS-compliant package. \*EP = Exposed pad.

Pin Configuration appears at end of data sheet.

SPI is a trademark of Motorola, Inc.

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For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

| OVDD, AVDD to GND0.3V to +3.6V                                  | Conti |
|---|-------|
| CMA, CMB, REFIO, INA+, INA-, INB+,                              | 48-   |
| INB- to GND0.3V to +2.1V  | (de   |
| CLK+, CLK-, SYNC, SPEN, CS, SCLK, SDIN                          | Opera |
| to GND0.3V to the lower of (VAVDD + 0.3V) and +3.6V             | Junct |
| DCLKA, DCLKB, D7A–D0A, D7B–D0B, DORA, DORB                      | Stora |
| to GND0.3V to the lower of (V <sub>OVDD</sub> + 0.3V) and +3.6V | Lead  |
|   | Solde |

Continuous Power Dissipation (T<sub>A</sub> = +70°C) 48-Pin Thin QFN, 7mm x 7mm x 0.8mm (derate 40mW/°C above +70°C)......3200mW Operating Temperature Range .....-40°C to +85°C Junction Temperature .....+150°C Storage Temperature Range .....-65°C to +150°C Lead Temperature (soldering, 10s).....+300°C Soldering Temperature (reflow) .....+260°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

| PARAMETER                          | SYMBOL          | SYMBOL CONDITIONS  |         | ТҮР  | MAX  | UNITS  |  |
|------------------------------------|-----------------|--|---------|------|------|--------|--|
| DC ACCURACY                        |                 | •  |         |      |      | •      |  |
| Resolution                         |                 |  |         | 8    |      | Bits   |  |
| Integral Nonlinearity              | INL             | f <sub>IN</sub> = 3MHz   | -0.3    | ±0.0 | +0.3 | LSB    |  |
| Differential Nonlinearity          | DNL             | f <sub>IN</sub> = 3MHz   | -0.3    | ±0.1 | +0.3 | LSB    |  |
| Offset Error                       | OE              | Internal reference   | -0.4    | ±0.1 | +0.4 | %FS    |  |
| Gain Error                         | GE              | External reference = 1.25V                                     | -1.5    | ±0.3 | +1.5 | %FS    |  |
| ANALOG INPUTS (INA+, INA-, IN      | B+, INB-) (Fig  | gure 3)  |         |      |      |        |  |
| Differential Input-Voltage Range   | VDIFF           | Differential or single-ended inputs                            |         | 1.5  |      | VP-P   |  |
| Common-Mode Input-Voltage<br>Range | V <sub>CM</sub> | (Note 2)   | 0.4 1.4 |      | 1.4  | V      |  |
| Input Resistance                   | RIN             | Fixed resistance, common mode, and differential mode           | > 100   |      |      | – kΩ   |  |
| input nesistance                   | NIU             | Differential input resistance, common mode connected to inputs | 4       |      |      |        |  |
| Input Current                      | I <sub>IN</sub> | Switched capacitance common-mode input current, each input     | 35      |      |      | μA     |  |
| Input Canacitanaa                  | CPAR            | Fixed capacitance to ground, each input                        | 0.7     |      |      |        |  |
| Input Capacitance                  | CSAMPLE         | Switched capacitance, each input                               | 1.2     |      |      | pF     |  |
| CONVERSION RATE                    |                 |  |         |      |      |        |  |
| Maximum Clock Frequency            | fCLK            |  | 65      |      |      | MHz    |  |
| Minimum Clock Frequency            | fCLK            |  | 30      |      | MHz  |        |  |
| Data Latency                       |                 | Figures 9, 10  |         | 9    |      | Cycles |  |

### **ELECTRICAL CHARACTERISTICS (continued)**

| PARAMETER   | SYMBOL | CONDITIONS   | MIN  | ТҮР   | MAX   | UNITS  |  |
|---|--------|--|------|-------|-------|--------|--|
| DYNAMIC PERFORMANCE                                       |        |  | •    |       |       | •      |  |
| Small-Signal Noise Floor                                  | SSNF   | $f_{IN} = 70MHz, < -35dBFS$                        |      | -49.8 |       | dBFS   |  |
|   |        | f <sub>IN</sub> = 3MHz                             |      | 49.8  |       |        |  |
| Signal-to-Noise Ratio                                     | SNR    | f <sub>IN</sub> = 70MHz                            | 49.0 | 49.8  |       | dBFS   |  |
|   |        | $f_{IN} = 175 MHz$                                 |      | 49.8  |       |        |  |
|   |        | f <sub>IN</sub> = 3MHz                             |      | 49.3  |       |        |  |
| Signal-to-Noise Plus Distortion                           | SINAD  | f <sub>IN</sub> = 70MHz                            | 48.5 | 49.3  |       | dB     |  |
| Ratio   |        | f <sub>IN</sub> = 175MHz                           |      | 49.3  |       |        |  |
| Spurious-Free Dynamic Range<br>(2nd and 3rd Harmonic)     |        | f <sub>IN</sub> = 3MHz                             |      | 77.0  |       |        |  |
|   | SFDR1  | f <sub>IN</sub> = 70MHz                            | 65.0 | 77.0  |       | dBc    |  |
|   |        | f <sub>IN</sub> = 175MHz                           |      | 77.0  |       |        |  |
|   | SFDR2  | f <sub>IN</sub> = 3MHz                             |      | 69.0  |       | dBc    |  |
| Spurious-Free Dynamic Range<br>(4th and Higher Harmonics) |        | f <sub>IN</sub> = 70MHz                            | 64.0 | 69.0  |       |        |  |
|   |        | f <sub>IN</sub> = 175MHz                           |      | 69.0  |       |        |  |
|   | HD2    | f <sub>IN</sub> = 3MHz                             |      | -78.0 |       |        |  |
| Second Harmonic   |        | f <sub>IN</sub> = 70MHz                            |      | -78.0 | -65.0 | dBc    |  |
|   |        | f <sub>IN</sub> = 175MHz                           |      | -78.0 |       | 1      |  |
|   |        | f <sub>IN</sub> = 3MHz                             |      | -82.0 |       |        |  |
| Third Harmonic  | HD3    | f <sub>IN</sub> = 70MHz                            |      | -82.0 | -65.0 | dBc    |  |
|   |        | f <sub>IN</sub> = 175MHz                           |      | -80.0 |       | 1      |  |
|   |        | f <sub>IN</sub> = 3MHz                             |      | -72.0 |       |        |  |
| Total Harmonic Distortion                                 | THD    | f <sub>IN</sub> = 70MHz                            |      | -72.0 | -63.0 | dBc    |  |
|   |        | f <sub>IN</sub> = 175MHz                           |      | -72.0 |       |        |  |
|   | 11.40  | $f_{IN} = 70MHz \pm 1.5MHz$ , -7dBFS               |      | -80   |       | 10     |  |
| Third-Order Intermodulation                               | IM3    | f <sub>IN</sub> = 175MHz ±2.5MHz, -7dBFS -75       |      |       | dBc   |        |  |
| Full-Power Bandwidth                                      | FPBW   | $R_{SOURCE} = 50\Omega$ differential, -3dB rolloff | İ    | 850   |       | MHz    |  |
| Aperture Delay  | tad    |  |      | 850   |       | ps     |  |
| Aperture Jitter   | taj    |  |      | 0.3   |       | psrms  |  |
| Overdrive Recovery Time                                   |        | ±10% beyond full scale                             |      | 1     |       | Cycles |  |

### **ELECTRICAL CHARACTERISTICS (continued)**

| PARAMETER   | SYMBOL             | CONDITIONS   | MIN  | ТҮР        | MAX  | UNITS   |  |
|---|--------------------|--|------|------------|------|---------|--|
| INTERCHANNEL CHARACTERIS  | TICS               |  | •    |            |      | •       |  |
|   |                    | $f_{INA}$ or $f_{INB} = 70$ MHz at -1dBFS                        | 95   |            |      |         |  |
| Crosstalk   |                    | $f_{INA}$ or $f_{INB} = 175$ MHz at -1dBFS                       |      | 85         |      | dBc     |  |
| Gain Match  |                    | f <sub>IN</sub> = 70MHz  |      | ±0.05      |      | dB      |  |
| Offset Match  |                    | f <sub>IN</sub> = 70MHz  |      | ±0.1       |      | %FSR    |  |
| Phase Match   |                    | $f_{IN} = 70MHz$   |      | ±0.5       |      | Degrees |  |
| ANALOG OUTPUTS (CMA, CMB)                                       |                    |  |      |            |      |         |  |
| CMA, CMB Output Voltage   | VCOM               | Default programmable setting                                     | 0.85 | 0.9        | 0.95 | V       |  |
| INTERNAL REFERENCE  |                    |  |      |            |      |         |  |
| REFIO Output Voltage  | VREFOUT            |  | 1.23 | 1.25       | 1.27 | V       |  |
| REFIO Temperature Coefficient                                   | TCREF              |  |      | < ±60      |      | ppm/°C  |  |
| EXTERNAL REFERENCE  |                    |  |      |            |      |         |  |
| REFIO Input-Voltage Range                                       | Vocent             |  |      | 1.25 +5/   |      | V       |  |
|   | VREFIN             |  |      | -10%       |      | v       |  |
| REFIO Input Resistance  | R <sub>REFIN</sub> |  |      | 10         |      | kΩ      |  |
|   |                    |  | ±20% |            |      |         |  |
| CLOCK INPUTS (CLK+, CLK-)                                       | DIFFERENTI         | AL MODE  | r    |            |      |         |  |
| Differential Clock Input Voltage                                |                    |  |      | 0.4 to 2.0 |      | VP-P    |  |
| Differential Input Common-Mode                                  |                    | Self-biased  |      | 1.20       |      | - v     |  |
| Voltage   |                    | DC-coupled clock signal  |      | 1.0 to 1.4 |      | v       |  |
|   |                    | Differential, default  |      | 10         |      | kΩ      |  |
| Input Resistance  | RCLK               | Differential, programmable internal termination selected         | 100  |            |      | Ω       |  |
|   |                    | Common mode  |      | 9          |      | kΩ      |  |
| Input Capacitance   | C <sub>CLK</sub>   | DC-coupled clock signal  |      | 3          |      | pF      |  |
| CLOCK INPUTS (CLK+, CLK-)-                                      | SINGLE-END         | ED MODE (V <sub>CLK-</sub> < 0.1V)                               |      |            |      |         |  |
| Single-Ended Mode Selection<br>Threshold (V <sub>CLK</sub> -)   |                    |  |      |            | 0.1  | V       |  |
| Allowable Logic Swing (V <sub>CLK+</sub> )                      |                    |  |      | 0 - Vavdd  |      | V       |  |
| Single-Ended Clock Input High<br>Threshold (V <sub>CLK+</sub> ) |                    |  | 1.5  |            |      | V       |  |
| Single-Ended Clock Input Low<br>Threshold (V <sub>CLK+</sub> )  |                    |  |      |            | 0.3  | V       |  |
| Input Leakage (CLK+)  |                    | $V_{CLK+} = V_{AVDD} = 1.8V \text{ or } 3.3V$<br>$V_{CLK+} = 0V$ | -0.5 |            | +0.5 | μA      |  |
| Input Leakage (CLK-)  |                    | V <sub>CLK-</sub> = 0V   | -150 |            | -50  | μA      |  |
| Input Capacitance (CLK+)  |                    |  |      | 3          |      | pF      |  |

### **ELECTRICAL CHARACTERISTICS (continued)**

| PARAMETER                       | SYMBOL           | CONDITIONS   | MIN                        | ТҮР       | MAX  | UNITS    |  |
|---------------------------------|------------------|--|----------------------------|-----------|------|----------|--|
| CLOCK INPUT (SYNC)              | •                | ·  | •                          |           |      | ·        |  |
| Allowable Logic Swing           |                  |  |                            | 0 - Vavde | )    | V        |  |
| Sync Clock Input High Threshold |                  |  | 1.5                        |           |      | V        |  |
| Sync Clock Input Low Threshold  |                  |  |                            |           | 0.3  | V        |  |
|                                 |                  | V <sub>SYNC</sub> = V <sub>AVDD</sub> = 1.8V or 3.3V                             |                            |           | +0.5 |          |  |
| Input Leakage                   |                  | V <sub>SYNC</sub> = 0V   | -0.5                       |           |      | μA       |  |
| Input Capacitance               |                  |  |                            | 4.5       |      | pF       |  |
| DIGITAL INPUTS (SHDN, SPEN)     |                  |  |                            |           |      |          |  |
| Allowable Logic Swing           |                  |  |                            | 0 - Vavde | )    | V        |  |
| Input High Threshold            |                  |  | 1.5                        |           |      | V        |  |
| Input Low Threshold             |                  |  |                            |           | 0.3  | V        |  |
|                                 |                  | V <sub>SHDN</sub> /V <sub>SPEN</sub> = V <sub>AVDD</sub> = 1.8V or 3.3V          |                            |           | +0.5 | μA       |  |
| Input Leakage                   |                  | $V_{SHDN}/V_{\overline{SPEN}} = 0V$  | -0.5                       |           |      |          |  |
| Input Capacitance               | C <sub>DIN</sub> |  |                            | 3         |      | pF       |  |
| SERIAL-PORT INPUTS (SCLK, S     | DIN, CS, whe     | ere SPEN = 0V)—SERIAL-PORT CONTROL I   | NODE                       |           |      |          |  |
| Allowable Logic Swing           |                  |  |                            | 0 - Vavde | )    | V        |  |
| Input High Threshold            |                  |  | 1.5                        |           |      | V        |  |
| Input Low Threshold             |                  |  |                            |           | 0.3  | V        |  |
|                                 |                  | $V_{SCLK}/V_{SDIN}/V_{\overline{CS}} = V_{AVDD} = 1.8V \text{ or } 3.3V$         |                            |           | +0.5 |          |  |
| Input Leakage                   |                  | $V_{SCLK}/V_{SDIN}/V_{\overline{CS}} = 0V$                                       | -0.5                       |           |      | μΑ       |  |
| Input Capacitance               | C <sub>DIN</sub> |  |                            | 3         |      | рF       |  |
| SERIAL-PORT INPUTS (SCLK, S     | DIN, CS, whe     | ere SPEN = V <sub>AVDD</sub> )—PARALLEL CONTROL                                  | MODE (Fig                  | gure 5)   |      | <u>.</u> |  |
|                                 |                  | $V_{SCLK}/V_{SDIN}/V_{\overline{CS}} = V_{AVDD} = 1.8V$                          | 7                          | 12        | 17   |          |  |
| Input Pullup Current            |                  | V <sub>SCLK</sub> /V <sub>SDIN</sub> /V <sub>CS</sub> = V <sub>AVDD</sub> = 3.3V | 16                         | 21        | 26   | μA       |  |
|                                 |                  | $V_{SCLK}/V_{SDIN}/V_{\overline{CS}} = 0V, V_{AVDD} = 1.8V$                      | -65                        | -50       | -35  |          |  |
| Input Pulldown Current          |                  | $V_{SCLK}/V_{SDIN}/V_{\overline{CS}} = 0V, V_{AVDD} = 3.3V$                      | -105                       | -90       | -75  | μA       |  |
|                                 | M                | V <sub>AVDD</sub> = 1.8V   | 1.35                       | 1.45      | 1.55 |          |  |
| Open-Circuit Voltage            | V <sub>OC</sub>  | $V_{AVDD} = 3.3V$  | 2.58                       | 2.68      | 2.78 | V        |  |
| DIGITAL OUTPUTS (CMOS MOD       | E, 75Ω, D0–D     | 07 (A and B Channel), DCLKA, DCLKB, DOF  | A, DORB)                   |           |      |          |  |
| Output-Voltage Low              | VOL              | I <sub>SINK</sub> = 200μA  |                            |           | 0.2  | V        |  |
| Output-Voltage High             | Voh              | ISOURCE = 200µA  | V <sub>OVDD</sub><br>- 0.2 |           |      | V        |  |
|                                 |                  | V <sub>OVDD</sub> applied  |                            |           | +0.5 | .5<br>μΑ |  |
| Three-State Leakage Current     | ILEAK            | GND applied  | -0.5                       |           |      |          |  |

### **ELECTRICAL CHARACTERISTICS (continued)**

| PARAMETER                               | SYMBOL          | CONDITIONS   | MIN        | ТҮР       | MAX | UNITS  |
|---|-----------------|--|------------|-----------|-----|--------|
| POWER-MANAGEMENT CHARA                  | CTERISTICS      | •  |            |           |     | •      |
| Wake-Up Time from Shutdown              | twake           | Internal reference, $C_{REFIO} = 0.1 \mu F (10\tau)$     |            | 5         |     | ms     |
| Wake-Up Time from Standby               | twake           | Internal reference                                       |            | 15        |     | μs     |
| SERIAL-PORT INTERFACE TIMIN             | IG (Note 2) (   | Figure 7)  | •          |           |     | •      |
| SCLK Period                             | <b>t</b> SCLK   |  | 50         |           |     | ns     |
| SCLK to CS Setup Time                   | tcss            |  | 10         |           |     | ns     |
| SCLK to $\overline{CS}$ Hold Time       | tсsн            |  | 10         |           |     | ns     |
| SDIN to SCLK Setup Time                 | tsds            | Serial-data write  | 10         |           |     | ns     |
| SDIN to SCLK Hold Time                  | tSDH            | Serial-data write  | 0          |           |     | ns     |
| SCLK to SDIN Output Data Delay          | tsdd            | Serial-data read   |            |           | 10  | ns     |
| TIMING CHARACTERISTICS-DU               | JAL BUS PA      | RALLEL MODE (Figure 9) (Default Timing, s                | see Table  | 5)        |     |        |
| Clock Pulse-Width High                  | tсн             |  |            | 7.69      |     | ns     |
| Clock Pulse-Width Low                   | tCL             |  |            | 7.69      |     | ns     |
| Clock Duty Cycle                        | tCH/tCLK        |  |            | 30 to 70  |     | %      |
| Data Delay After Rising Edge of CLK+    | tDD             | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 3.4        | 5.3       | 7.1 |        |
|   |                 | $C_L = 10 pF, V_{OVDD} = 3.3 V$                          |            | 4.1       |     | ns     |
| Data to DCLK Setup Time                 | <b>t</b> SETUP  | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 12.8       | 13.4      |     | ns     |
| Data to DCLK Hold Time                  | thold           | $C_{L} = 10 pF, V_{OVDD} = 1.8 V$ (Note 2)               | 1.4        | 2.0       |     | ns     |
| TIMING CHARACTERISTICS-MI               | JLTIPLEXED      | BUS PARALLEL MODE (Figure 10) (Defau                     | It Timing, | see Table | 5)  |        |
| Clock Pulse-Width High                  | tсн             |  |            | 7.69      |     | ns     |
| Clock Pulse-Width Low                   | t <sub>CL</sub> |  |            | 7.69      |     | ns     |
| Clock Duty Cycle                        | tCH/tCLK        |  |            | 30 to 70  |     | %      |
| Data Delay After Rising Edge of         |                 | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 3.3        | 5.2       | 7.0 |        |
| CLK+                                    | tDD             | $C_L = 10 pF, V_{OVDD} = 3.3 V$                          |            | 4.0       |     | ns     |
| Data to DCLK Setup Time                 | <b>t</b> SETUP  | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 5.0        | 5.9       |     | ns     |
| Data to DCLK Hold Time                  | thold           | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 1.2        | 1.8       |     | ns     |
| DCLK Duty Cycle                         | tDCH/tCLK       | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 44         | 50        | 56  | %      |
| MUX Data Duty Cycle                     | tCHA/tCLK       | C <sub>L</sub> = 10pF, V <sub>OVDD</sub> = 1.8V (Note 2) | 44         | 50        | 56  | %      |
| TIMING CHARACTERISTICS—SY               | NCHRONIZ        | ATION (Figure 12)  |            |           |     |        |
| Setup Time for Valid Clock Edge         | tsuv            | Edge mode (Note 2)                                       | 0.7        |           |     | ns     |
| Hold-Off Time for Invalid Clock<br>Edge | tsdh            | Edge mode (Note 2)                                       | 0.5        |           |     | ns     |
| Minimum Synchronization Pulse<br>Width  |                 | Relative to input clock period                           |            | 2         |     | Cycles |

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{AVDD} = V_{OVDD} = 1.8V, internal reference, differential clock, V_{CLK} = 1.5V_{P-P}, f_{CLK} = 65MHz, A_{IN} = -0.5dBFS, data output termination = 50\Omega, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)$ 

| PARAMETER                      | SYMBOL          | CONDITIONS   | MIN | ТҮР   | MAX | UNITS      |  |  |
|--------------------------------|-----------------|--|-----|-------|-----|------------|--|--|
| POWER REQUIREMENTS             |                 |  | •   |       |     | •          |  |  |
|                                |                 | Low-level VAVDD  | 1.7 |       | 1.9 | 1.9<br>3.5 |  |  |
| Analog Supply Voltage          | Vavdd           | High-level V <sub>AVDD</sub> (regulator mode, invoked automatically) | 2.3 |       | 3.5 |            |  |  |
| Digital Output Supply Voltage  | Vovdd           |  | 1.7 |       | 3.5 | V          |  |  |
|                                |                 | Dual channel   |     | 47    | 55  | mA         |  |  |
|                                |                 | Single channel active  |     | 28    |     |            |  |  |
| Analog Supply Current          | IAVDD           | Standby mode   |     | 8.5   | 12  |            |  |  |
|                                |                 | Power-down mode  |     | 0.65  | 0.9 |            |  |  |
|                                |                 | Power-down mode, V <sub>AVDD</sub> = 3.3V                            |     | 1.6   |     | 1          |  |  |
|                                |                 | Dual channel   |     | 85    | 99  |            |  |  |
|                                |                 | Dual channel, V <sub>AVDD</sub> = 3.3V                               |     | 155   |     |            |  |  |
| Analas Dawar Disaination       |                 | Single channel active  |     | 50    |     | mW         |  |  |
| Analog Power Dissipation       | P <sub>DA</sub> | Standby mode   |     | 15    | 22  | TUV        |  |  |
|                                |                 | Power-down mode  |     | 1.2   | 1.6 |            |  |  |
|                                |                 | Power-down mode, V <sub>AVDD</sub> = 3.3V 2.9                        |     |       | ]   |            |  |  |
| Disitel Outsut Sussely Oursent |                 | Dual-channel mode, $C_L = 10 pF$                                     |     | 11    |     |            |  |  |
| Digital Output Supply Current  | IOVDD           | Power-down mode  |     | < 0.1 |     | mA         |  |  |

**Note 1:** Specifications  $\geq$  +25°C guaranteed by production test, specifications < +25°C guaranteed by design and characterization. **Note 2:** Guaranteed by design and characterization.

=  $50\Omega$ , T<sub>A</sub> = +25°C, unless otherwise noted.)



(VAVDD = VOVDD = 1.8V, internal reference, differential clock, VCLK = 1.5VP-P, fCLK = 65MHz, AIN = -0.5dBFS, data output termination

**Typical Operating Characteristics** 



(VAVDD = VOVDD = 1.8V, internal reference, differential clock, VCLK = 1.5VP-P, fCLK = 65MHz, AIN = -0.5dBFS, data output termination = 50 $\Omega$ , T<sub>A</sub> = +25°C, unless otherwise noted.)





///XI//

MAX19505



 $(V_{AVDD} = V_{OVDD} = 1.8V, internal reference, differential clock, V_{CLK} = 1.5V_{P-P}, f_{CLK} = 65MHz, A_{IN} = -0.5dBFS, data output termination = 50\Omega, T_A = +25°C, unless otherwise noted.)$ 



COMMON-MODE VOLTAGE (V)

SUPPLY VOLTAGE (V)

**MAX19505** 

| Din | Doc | orin | tion |
|-----|-----|------|------|
|     | DES | crip |      |

| PIN           | NAME  | FUNCTION  |
|---------------|-------|---|
| 1, 12, 13, 48 | AVDD  | Analog Supply Voltage. Bypass each AVDD input pair (1, 48) and (12, 13) to GND with 0.1µF.  |
| 2             | CMA   | Channel A Common-Mode Input-Voltage Reference   |
| 3             | INA+  | Channel A Positive Analog Input   |
| 4             | INA-  | Channel A Negative Analog Input   |
| 5             | SPEN  | Active-Low SPI Enable. Drive high to enable parallel programming mode.  |
| 6             | REFIO | Reference Input/Output. To use internal reference, bypass to GND with a > 0.1µF capacitor. See the <i>Reference Input/Output (REFIO)</i> section for external reference adjustment. |
| 7             | SHDN  | Active-High Power-Down. If SPEN is high (parallel programming mode), a register reset is initiated on the falling edge of SHDN.   |
| 8             | I.C.  | Internally Connected. Leave unconnected.  |
| 9             | INB+  | Channel B Positive Analog Input   |
| 10            | INB-  | Channel B Negative Analog Input   |
| 11            | CMB   | Channel B Common-Mode Input-Voltage Reference   |
| 14            | SYNC  | Clock-Divider Mode Synchronization Input  |
| 15            | CLK+  | Clock Positive Input  |
| 16            | CLK-  | Clock Negative Input. If CLK- is connected to ground, CLK+ is a single-ended logic-level clock input. Otherwise, CLK+/CLK- are self-biased differential clock inputs.               |
| 17, 18        | GND   | Ground. Connect all ground inputs and EP (exposed pad) together.  |
| 19            | DORB  | Channel B Data Over Range   |
| 20            | DCLKB | Channel B Data Clock  |
| 21            | I.C.  | Internally Connected. Leave unconnected.  |
| 22            | I.C.  | Internally Connected. Leave unconnected.  |
| 23            | D0B   | Channel B Three-State Digital Output, Bit 0 (LSB)   |
| 24            | D1B   | Channel B Three-State Digital Output, Bit 1   |
| 25, 36        | OVDD  | Digital Supply Voltage. Bypass each OVDD input to GND with 0.1µF capacitor.   |
| 26            | D2B   | Channel B Three-State Digital Output, Bit 2   |
| 27            | D3B   | Channel B Three-State Digital Output, Bit 3   |
| 28            | D4B   | Channel B Three-State Digital Output, Bit 4   |
| 29            | D5B   | Channel B Three-State Digital Output, Bit 5   |
| 30            | D6B   | Channel B Three-State Digital Output, Bit 6   |
| 31            | D7B   | Channel B Three-State Digital Output, Bit 7 (MSB)   |
| 32, 33        | I.C.  | Internally Connected. Leave unconnected.  |
| 34            | D0A   | Channel A Three-State Digital Output, Bit 0 (LSB)   |
| 35            | D1A   | Channel A Three-State Digital Output, Bit 1   |
| 37            | D2A   | Channel A Three-State Digital Output, Bit 2   |
| 38            | D3A   | Channel A Three-State Digital Output, Bit 3   |
| 39            | D4A   | Channel A Three-State Digital Output, Bit 4   |

### **Pin Description (continued)**

| PIN  | NAME        | FUNCTION  |  |
|--|-------------|---|--|
| 40   | D5A         | Channel A Three-State Digital Output, Bit 5   |  |
| 41   | D6A         | Channel A Three-State Digital Output, Bit 6   |  |
| 42   | D7A         | Channel A Three-State Digital Output, Bit 7 (MSB)   |  |
| 43   | DORA        | Channel A Data Over Range   |  |
| 44   | DCLKA       | Channel A Data Clock  |  |
| 45   | SDIN/FORMAT | SPI Data Input/Format. Serial-data input when SPEN is low. Output data format when SPEN is high.                        |  |
| 46   | SCLK/DIV    | Serial Clock/Clock Divider. Serial clock when SPEN is low. Clock divider when SPEN is high.                             |  |
| 47   | CS/OUTSEL   | Serial-Port Select/Data Output Mode. Serial-port select when SPEN is low. Data output mode selection when SPEN is high. |  |
| EP         Exposed Pad. Internally connected to GND. Connect to a large ground plane to performance. |             | Exposed Pad. Internally connected to GND. Connect to a large ground plane to maximize thermal performance.              |  |

### **Detailed Description**

The MAX19505 uses a 10-stage, fully differential, pipelined architecture (Figure 1) that allows for highspeed conversion while minimizing power consumption. Samples taken at the inputs move progressively through the pipeline stages every half clock cycle. From input to output, the total latency is 9 clock cycles. Each pipeline converter stage converts its input voltage to a digital output code. At every stage, except the last, the error between the input voltage and the digital output code is multiplied and passed on to the next pipeline stage. Digital error correction compensates for ADC comparator offsets in each pipeline stage and ensures no missing codes. Figure 2 shows the MAX19505 functional diagram.

#### Analog Inputs and Common-Mode Reference

Apply the analog input signal to the analog inputs (INA+/INA- or INB+/INB-), which are connected to the input sampling switch (Figure 3). When the input sampling switch is closed, the input signal is applied to the sampling capacitors through the input switch resistance. The input signal is sampled at the instant the input switch opens. The pipeline ADC processes the sampled voltage and the digital output result is available 9 clock cycles later. Before the input switch is closed to begin the next sampling cycle, the sampling capacitors are reset to the input common-mode potential.

Common-mode bias can be provided externally or internally through  $2k\Omega$  resistors. In DC-coupled applications, the signal source provides the external bias and the bias current. In AC-coupled applications, the input

current is supplied by the common-mode input voltage. For example, the input current can be supplied through the center tap of a transformer secondary winding. Alternatively, program the appropriate internal register through the serial-port interface to supply the input DC current through internal  $2k\Omega$  resistors (Figure 3). When the input current is supplied through the internal resistors, the input common-mode potential is reduced by the voltage drop across the resistors. The common-mode input reference voltage can be adjusted through programmable register settings from 0.45V to 1.35V in 0.15V increments. The default setting is 0.90V. Use this feature to provide a common-mode output reference to a DC-coupled driving circuit.



Figure 1. Pipeline Architecture—Stage Blocks

Dual-Channel, 8-Bit, 65Msps ADC



Figure 2. Functional Diagram

MAX19505



Figure 3. Internal Track-and-Hold (T/H) Circuit



Figure 4. Simplified Reference Schematic

### Table 1. Parallel-Interface Pin Functionality



Figure 5. Simplified Parallel-Interface Input Schematic

| SPEN | SDIN/FORMAT | SCLK/DIV    | CS/OUTSEL   | DESCRIPTION  |  |  |  |  |  |
|------|-------------|-------------|-------------|--|--|--|--|--|--|
| 0    | SDIN        | SCLK        | CS          | SPI interface active. Features are programmed through the serial port (see the <i>Serial Programming Interface</i> section). |  |  |  |  |  |
| 1    | 0           | Х           | Х           | Two's complement   |  |  |  |  |  |
| 1    | AVDD        | Х           | Х           | Offset binary  |  |  |  |  |  |
| 1    | Unconnected | Х           | Х           | Gray code  |  |  |  |  |  |
| 1    | Х           | 0           | Х           | Clock divide-by-1  |  |  |  |  |  |
| 1    | Х           | AVDD        | Х           | Clock divide-by-2  |  |  |  |  |  |
| 1    | Х           | Unconnected | Х           | Clock divide-by-4  |  |  |  |  |  |
| 1    | Х           | Х           | 0           | CMOS (dual bus)  |  |  |  |  |  |
| 1    | Х           | Х           | AVDD        | MUX CMOS (channel A data bus)  |  |  |  |  |  |
| 1    | Х           | Х           | Unconnected | MUX CMOS (channel B data bus)  |  |  |  |  |  |

X = Don't care.

#### **Reference Input/Output (REFIO)**

REFIO adjusts the reference potential, which, in turn, adjusts the full-scale range of the ADC. Figure 4 shows a simplified schematic of the reference system. An internal bandgap voltage generator provides an internal reference voltage. The bandgap potential is buffered and applied to REFIO through a 10k $\Omega$  resistor. Bypass REFIO with a 0.1µF capacitor to GND. The bandgap voltage is applied to a scaling and level-shift circuit, which creates internal reference potentials that establish the full-scale range of the ADC. Apply an external voltage on REFIO to trim the ADC full scale. The allowable adjustment range is +5/-15%. The REFIO-to-ADC gain transfer function is:

VFS = 1.5 x [VREFIO/1.25] Volts

#### **Programming and Interface**

There are two ways to control the MAX19505 operating modes. Full feature selection is available using the SPI interface, while the parallel interface offers a limited set of commonly used features. The programming mode is selected using the SPEN input. Drive SPEN low for SPI interface; drive SPEN high for parallel interface.

#### **Parallel Interface**

The parallel interface offers a pin-programmable interface with a limited feature set. Connect SPEN to AVDD to enable the parallel interface. See Table 1 for pin functionality; see Figure 5 for a simplified parallel-interface input schematic.



Figure 6. Serial-Interface Communication Cycle



Figure 7. Serial-Interface Timing Diagram

**Serial Programming Interface** 

A serial interface programs the MAX19505 control registers through the  $\overline{CS}$ , SDIN, and SCLK inputs. Serial data is shifted into SDIN on the rising edge of SCLK when  $\overline{CS}$  is low. The MAX19505 ignores the data presented at SDIN and SCLK when  $\overline{CS}$  is high.  $\overline{CS}$  must transition high after each read/write operation. SDIN also serves as the serial-data output for reading control registers. The serial interface supports two-byte transfer in a communication cycle. The first byte is a control byte, containing the address and read/write instruction, written to the MAX19505. The second byte is a data byte and can be written to or read from the MAX19505.

Figure 6 shows a serial-interface communication cycle. The first SDIN bit clocked in establishes the

communication cycle as either a write or read transaction (0 for write operation and 1 for read operation). The following 7 bits specify the address of the register to be written or read. The final 8 SDIN bits are the register data. All address and data bits are clocked in or out MSB first. During a read operation, the MAX19505 serial port drives read data (D7) into SDIN after the falling edge of SCLK following the 8th rising edge of SCLK. Since the minimum hold time on SDIN input is zero, the master can stop driving SDIN any time after the 8th rising edge of SCLK. Subsequent data bits are driven into SDIN on the falling edge of SCLK. Output data in a read operation is latched on the rising edge of SCLK. Figure 7 shows the detailed serial-interface timing diagram.

Register address 0Ah is a special-function register. Writing data 5Ah to register 0Ah initiates a register reset. When this operation is executed, all control registers

#### Table 2. Register 0Ah Status Byte

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are reset to default values. A read operation of register 0Ah returns a status byte with information described in Table 2.

**User-Programmable Registers** 

| BIT NO. | VALUE  | DESCRIPTION  |
|---------|--------|--|
| 7       | 0      | Reserved   |
| 6       | 0      | Reserved   |
| 5       | 0 or 1 | 1 = ROM read in progress   |
| 4       | 0 or 1 | 1 = ROM read completed and register data is valid (checksum is OK) |
| 3       | 0      | Reserved   |
| 2       | 1      | Reserved   |
| 1       | 0 or 1 | Reserved   |
| 0       | 0 or 1 | 1 = Duty-cycle equalizer DLL is locked                             |

### Table 3. User-Programmable Registers

| ADDRESS | POR DEFAULT | FUNCTION                              |
|---------|-------------|---------------------------------------|
| 00h     | 00000011    | Power management                      |
| 01h     | 0000000     | Output format                         |
| 02h     | 00000000    | Digital output power management       |
| 03h     | 1000000     | Data/DCLK timing                      |
| 04h     | 00000000    | CHA data output termination control   |
| 05h     | 00000000    | CHB data output termination control   |
| 06h     | 00000000    | Clock divide/data format/test pattern |
| 07h     | Reserved    | Reserved—do not use                   |
| 08h     | 00000000    | Common mode                           |
| 0Ah     | _           | Software reset                        |

#### Power Management (00h)

| BIT 7     | BIT 6      | BIT 5        | BIT 4        | BIT 3     | BIT 2      | BIT 1        | BIT 0        |
|-----------|------------|--------------|--------------|-----------|------------|--------------|--------------|
| HPS_SHDN1 | STBY_SHDN1 | CHB_ON_SHDN1 | CHA_ON_SHDN1 | HPS_SHDN0 | STBY_SHDN0 | CHB_ON_SHDN0 | CHA_ON_SHDN0 |

The SHDN input (pin 7) toggles between any two power-management states. The Power Management register defines each power-management state. In the default state, SHDN = 1 shuts down the MAX19505 and SHDN = 0 returns to full power.

In addition to power management, the HPS\_SHDN1 and HPS\_SHDN0 activate an A+B adder mode. In this mode, the results from both channels are averaged.

The MUX\_CH bit selects which bus the (A+B)/2 data is presented.

#### **Control Bits:**

| HPS_SHDN0 | STBY_SHDN0 | CHA_ON_SHDN0 | CHB_ON_SHDN0 | SHDN INPUT = 0*                             |
|-----------|------------|--------------|--------------|---|
| HPS_SHDN1 | STBY_SHDN1 | CHA_ON_SHDN1 | CHB_ON_SHDN1 | SHDN INPUT = 1**                            |
| Х         | 0          | 0            | 0            | Complete power-down                         |
| 0         | 0          | 0            | 1            | Channel B active, channel A full power-down |
| 0         | 0          | 1            | 0            | Channel A active, channel B full power-down |
| 0         | Х          | 1            | 1            | Channels A and B active                     |
| 0         | 1          | 0            | 0            | Channels A and B in standby mode            |
| 0         | 1          | 0            | 1            | Channel B active, channel A standby         |
| 0         | 1          | 1            | 0            | Channel A active, channel B standby         |
| 1         | 1          | 0            | 0            | Channels A and B in standby mode            |
| 1         | Х          | Х            | 1            | Channels A and B active, output is averaged |
| 1         | Х          | 1            | Х            | Channels A and B active, output is averaged |

\*HPS\_SHDN0, STBY\_SHDN0, CHA\_ON\_SHDN\_, and CHB\_ON\_SHDN\_ are active when SHDN = 0.

\*\*HPS\_SHDN1, STBY\_SHDN1, CHA\_ON\_SHDN1, and CHB\_ON\_SHDN1 are active when SHDN = 1.

X = Don't care.

**Note:** When HPS\_SHDN\_ = 1 (A+B adder mode), CHA\_ON\_SHDN\_ and CHB\_ON\_SHDN\_ must **BOTH** equal 0 for power-down or standby.

### Output Format (01h)

| BIT 7       | BIT 6                                       | BIT 5                                     | BIT 4                   | BIT 3                      | BIT 2      | BIT 1        | BIT 0 |  |  |  |
|-------------|---|---|-------------------------|----------------------------|------------|--------------|-------|--|--|--|
| 0           | 0   | 0   | BIT_ORDER_B             | BIT_ORDER_A                | MUX_CH     | MUX          | 0     |  |  |  |
| Bit 7, 6, 5 | Set to 0 for                                | Set to 0 for proper operation             |                         |                            |            |              |       |  |  |  |
| Bit 4       | BIT_ORDE                                    | BIT_ORDER_B: Reverse CHB output bit order |                         |                            |            |              |       |  |  |  |
|             | 0 = Define                                  | d data bus                                | pin order (default)     |                            |            |              |       |  |  |  |
|             | 1 = Revers                                  | se data bus                               | pin order               |                            |            |              |       |  |  |  |
| Bit 3       | BIT_ORDE                                    | R_A: Rever                                | se CHA output bit order |                            |            |              |       |  |  |  |
|             | 0 = Define                                  | d data bus                                | pin order (default)     |                            |            |              |       |  |  |  |
|             | 1 = Revers                                  | se data bus                               | pin order               |                            |            |              |       |  |  |  |
| Bit 2       | MUX_CH:                                     | Multiplexed                               | data bus selection      |                            |            |              |       |  |  |  |
|             | 0 = Multipl                                 | exed data c                               | output on CHA (CHA da   | ta presented first, follow | ed by CHB  | data) (defau | ılt)  |  |  |  |
|             | 1 = Multipl                                 | exed data c                               | output on CHB (CHB da   | ta presented first, follow | ved by CHA | data)        |       |  |  |  |
| Bit 1       | MUX: Digit                                  | tal output m                              | ode                     |                            |            |              |       |  |  |  |
|             | 0 = Dual d                                  | ata bus out                               | put mode (default)      |                            |            |              |       |  |  |  |
|             | 1 = Single multiplexed data bus output mode |   |                         |                            |            |              |       |  |  |  |
|             | MUX_(                                       | MUX_CH selects the output bus             |                         |                            |            |              |       |  |  |  |
| Bit 0       | Set to 0 for                                | r proper ope                              | eration                 |                            |            |              |       |  |  |  |

| BIT 7    | BIT 6   | BIT 5            | BIT 4 | BIT 3     | BIT 2     | BIT 1   | BIT 0    |  |  |
|----------|---|------------------|-------|-----------|-----------|---------|----------|--|--|
| Х        | Х   | Х                | Х     | PD_DOUT_1 | PD_DOUT_0 | DIS_DOR | DIS_DCLK |  |  |
| Bit 7–4  | Don't care  |                  |       |           |           |         |          |  |  |
| Bit 3, 2 | PD_DOUT_1, PD_DOUT_0: Power-down digital output state control |                  |       |           |           |         |          |  |  |
|          | 00 = Digital output three state (default)                     |                  |       |           |           |         |          |  |  |
|          | 01 = Digital output low                                       |                  |       |           |           |         |          |  |  |
|          | 10 = Digital output three state                               |                  |       |           |           |         |          |  |  |
|          | 11 = Digital outp   | out high         |       |           |           |         |          |  |  |
| Bit 1    | DIS_DOR: DOR  | driver disable   |       |           |           |         |          |  |  |
|          | 0 = DOR active  | (default)        |       |           |           |         |          |  |  |
|          | 1 = DOR disable   | ed (three state) |       |           |           |         |          |  |  |
| Bit 0    | DIS_DCLK: DCLK driver disable                                 |                  |       |           |           |         |          |  |  |
|          | 0 = DCLK active (default)                                     |                  |       |           |           |         |          |  |  |
|          | 1 = DCLK disabled (three state)                               |                  |       |           |           |         |          |  |  |

### **Digital Output Power Management (02h)**

### Data/DCLK Timing (03h)

| BIT 7       | BIT 6                          | BIT 5                             | BIT 4                               | BIT 3                              | BIT 2                           | BIT 1                             | BIT 0                 |  |
|-------------|--------------------------------|-----------------------------------|-------------------------------------|------------------------------------|---------------------------------|-----------------------------------|-----------------------|--|
| DA_BYPAS    |                                | DCLKTIME_2                        | DCLKTIME_1                          | DCLKTIME_0                         | DTIME_2                         | DTIME_1                           | DTIME_0               |  |
| Bit 7       | DA_BYPASS: Da                  | ta aligner bypa                   | ass                                 |                                    |                                 |                                   |                       |  |
|             | 0 = Nominal                    |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 1 = Bypasses d<br>Rising clock | ata aligner de<br>to data transit | lay line to mini<br>ion is approxin | imize output da<br>nately 6ns with | ata latency wit<br>DTIME = 000b | h respect to th<br>settings (defa | ne input cloc<br>ult) |  |
| Bit 6       | DLY_HALF_T: Da                 | ata and DCLK                      | delayed by T/2                      |                                    |                                 |                                   |                       |  |
|             | 0 = Normal, no d               | lelay (default)                   |                                     |                                    |                                 |                                   |                       |  |
|             | 1 = Delays data                | and DCLK out                      | outs by T/2                         |                                    |                                 |                                   |                       |  |
|             | Disabled in N                  | MUX data bus                      | mode                                |                                    |                                 |                                   |                       |  |
| Bit 5, 4, 3 | DCLKTIME_2, D                  | CLKTIME_1, D                      | CLKTIME_0: D                        | CLK timing adju                    | ust (controls be                | oth channels)                     |                       |  |
|             | 000 = Nominal (c)              | default)                          |                                     |                                    |                                 |                                   |                       |  |
|             | 001 = +T/16                    |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 010 = +2T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 011 = +3T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 100 = Reserved,                | do not use                        |                                     |                                    |                                 |                                   |                       |  |
|             | 101 = -1T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 110 = -2T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 111 = -3T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
| Bit 2, 1, 0 | DTIME_2, DTIME                 | E_1, DTIME_0:                     | Data timing ad                      | just (controls be                  | oth channels)                   |                                   |                       |  |
|             | 000 = Nominal (c)              | default)                          |                                     |                                    |                                 |                                   |                       |  |
|             | 001 = +T/16                    |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 010 = +2T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 011 = +3T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 100 = Reserved,                | do not use                        |                                     |                                    |                                 |                                   |                       |  |
|             | 101 = -1T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |
|             | 110 = -2T/16                   |                                   |                                     |                                    |                                 |                                   |                       |  |

111 = -3T/16

### CHA Data Output Termination Control (04h)

| BIT 7                                     | BIT 6      | BIT 5   | BIT 4         | BIT 3         | BIT 2             | BIT 1         | BIT 0       |  |  |
|---|------------|---|---------------|---------------|-------------------|---------------|-------------|--|--|
| Х   | Х          | CT_DCLK_2_A   | CT_DCLK_1_A   | CT_DCLK_0_A   | CT_DATA_2_A       | CT_DATA_1_A   | CT_DATA_0_A |  |  |
| Bit 7, 6                                  | Don't ca   | are   |               |               |                   |               |             |  |  |
| Bit 5, 4, 3                               | CT_DCI     | CT_DCLK_2_A, CT_DCLK_1_A, CT_DCLK_0_A: CHA DCLK termination control |               |               |                   |               |             |  |  |
|   | 000 = 5    | 0 $\Omega$ (default)  |               |               |                   |               |             |  |  |
|   | 001 = 7    | 5Ω  |               |               |                   |               |             |  |  |
|   | 010 = 1    | 00Ω   |               |               |                   |               |             |  |  |
|   | 011 = 1    | 50Ω   |               |               |                   |               |             |  |  |
|   | 1xx = 3    | $\Omega 00$   |               |               |                   |               |             |  |  |
| Bit 2, 1, 0                               | CT_DA1     | FA_2_A, CT_DAT  | A_1_A, CT_DAT | A_0_A: CHA da | ta output termina | ation control |             |  |  |
|   | 000 = 5    | 0 $\Omega$ (default)  |               |               |                   |               |             |  |  |
|   | 001 = 7    | 5Ω  |               |               |                   |               |             |  |  |
|   | 010 = 1    | 00Ω   |               |               |                   |               |             |  |  |
|   | 011 = 1    | 011 = 150Ω  |               |               |                   |               |             |  |  |
|   | 1xx = 300Ω |   |               |               |                   |               |             |  |  |
| CHB Data Output Termination Control (05h) |            |   |               |               |                   |               |             |  |  |

| BIT 7 | BIT 6 | BIT 5       | BIT 4       | BIT 3       | BIT 2       | BIT 1       | BIT 0       |
|-------|-------|-------------|-------------|-------------|-------------|-------------|-------------|
| Х     | Х     | CT_DCLK_2_B | CT_DCLK_1_B | CT_DCLK_0_B | CT_DATA_2_B | CT_DATA_1_B | CT_DATA_0_B |

Bit 7, 6 Don't care

Bit 5, 4, 3 CT\_DCLK\_2\_B, CT\_DCLK\_1\_B, CT\_DCLK\_0\_B: CHB DCLK termination control

 $000 = 50\Omega$  (default)

- $001 = 75\Omega$  $010 = 100\Omega$
- $011 = 150\Omega$
- $1xx = 300\Omega$
- Bit 2, 1, 0 CT\_DATA\_2\_B, CT\_DATA\_1\_B, CT\_DATA\_0\_B: CHB data output termination control
  - $000 = 50\Omega$  (default)
  - $001 = 75\Omega$
  - $010 = 100\Omega$
  - $011 = 150\Omega$
  - $1xx = 300\Omega$

| BIT 7    | 7                                    | BIT 6                               | BIT 5                   | BIT 4              | BIT 3            | BIT 2            | BIT 1        | BIT 0   |  |  |
|----------|--------------------------------------|-------------------------------------|-------------------------|--------------------|------------------|------------------|--------------|---------|--|--|
| TEST_PAT | TERN                                 | TEST_DATA                           | FORMAT_1                | FORMAT_0           | TERM_100         | SYNC_MODE        | DIV1         | DIV0    |  |  |
| Bit 7    | TEST_PATTERN: Test pattern selection |                                     |                         |                    |                  |                  |              |         |  |  |
|          | 0 =                                  | Ramps from 0 to                     | o 255 (offset bir       | ary) and repeat    | s (subsequent fo | ormatting applie | d) (default) |         |  |  |
|          |                                      | Data alterna<br>DOR = 0 on bot      |                         | D[7:0] = 010       | )10101, DOR      | = 1, and D       | [7:0] = 1    | 0101010 |  |  |
| Bit 6    | TES                                  | T_DATA: Data t                      | est mode                |                    |                  |                  |              |         |  |  |
|          | 0 =                                  | Normal data ou                      | tput (default)          |                    |                  |                  |              |         |  |  |
|          | 1 =                                  | Outputs test da                     | ta pattern              |                    |                  |                  |              |         |  |  |
| Bit 5, 4 | FOF                                  | RMAT_1, FORM                        | AT_0: Data num          | erical format      |                  |                  |              |         |  |  |
|          | 00 = Two's complement (default)      |                                     |                         |                    |                  |                  |              |         |  |  |
|          | 01 =                                 | = Offset binary                     |                         |                    |                  |                  |              |         |  |  |
|          | 10 =                                 | = Gray code                         |                         |                    |                  |                  |              |         |  |  |
|          | 11 =                                 | = Two's compler                     | ment                    |                    |                  |                  |              |         |  |  |
| Bit 3    | TER                                  | M_100: Select                       | 100 $\Omega$ clock inpu | it termination     |                  |                  |              |         |  |  |
|          | 0 =                                  | No termination (                    | (default)               |                    |                  |                  |              |         |  |  |
|          | 1 =                                  | 100 $\Omega$ terminatio             | on across differe       | ential clock input | S                |                  |              |         |  |  |
| Bit 2    | SYN                                  | IC_MODE: Divid                      | der synchronizat        | tion mode select   | t                |                  |              |         |  |  |
|          | 0 =                                  | 0 = Slip mode (Figure 11) (default) |                         |                    |                  |                  |              |         |  |  |
|          | 1 =                                  | Edge mode (Fig                      | gure 12)                |                    |                  |                  |              |         |  |  |
| Bit 1, 0 | DIV                                  | 1, DIV0: Input cl                   | ock-divider sele        | ect                |                  |                  |              |         |  |  |
|          | 00 =                                 | = No divider (de                    | fault)                  |                    |                  |                  |              |         |  |  |
|          | 01 =                                 | = Divide-by-2                       |                         |                    |                  |                  |              |         |  |  |
|          |                                      | = Divide-by-4                       |                         |                    |                  |                  |              |         |  |  |
|          | 11 =                                 | = No divider                        |                         |                    |                  |                  |              |         |  |  |

### ~

Reserved (07h)—Do not write to this register

### Common Mode (08h)

| Common      |  |               |                |                  |                        |                |             |  |
|-------------|--|---------------|----------------|------------------|------------------------|----------------|-------------|--|
| BIT 7       | BIT 6  | BIT 5         | BIT 4          | BIT 3            | BIT 2                  | BIT 1          | BIT 0       |  |
| CMI_SELF_   | _B CMI_ADJ_2_B   | CMI_ADJ_1_B   | CMI_ADJ_0_B    | CMI_SELF_A       | CMI_ADJ_2_A            | CMI_ADJ_1_A    | CMI_ADJ_0_A |  |
| Bit 7       | CMI_SELF_B: CH   | B connect inp | ut common-mo   | ode to analog ir | nputs                  |                |             |  |
|             | 0 = Internal common-mode voltage is NOT applied to inputs (default)                    |               |                |                  |                        |                |             |  |
|             | 1 = Internal common-mode voltage applied to analog inputs through $2k\Omega$ resistors |               |                |                  |                        |                |             |  |
| Bit 6, 5, 4 | CMI_ADJ_2_B, C   | MI_ADJ_1_B,   | CMI_ADJ_0_B    | : CHB input co   | mmon-mode vo           | oltage adjustm | ent         |  |
|             | 000 = 0.900V (de   | efault)       |                |                  |                        | 0 /            |             |  |
|             | 001 = 1.050V   |               |                |                  |                        |                |             |  |
|             | 010 = 1.200V   |               |                |                  |                        |                |             |  |
|             | 011 = 1.350V   |               |                |                  |                        |                |             |  |
|             | 100 = 0.900 V  |               |                |                  |                        |                |             |  |
|             | 101 = 0.750V   |               |                |                  |                        |                |             |  |
|             | 110 = 0.600V   |               |                |                  |                        |                |             |  |
|             | 111 = 0.450V   |               |                |                  |                        |                |             |  |
| Bit 3       | CMI_SELF_A: CH   | A connect inp | ut common-mo   | ode to analog ir | nputs                  |                |             |  |
|             | 0 = Internal com   | mon-mode volt | age is NOT ap  | plied to inputs  | (default)              |                |             |  |
|             | 1 = Internal com   | mon-mode volt | age applied to | analog inputs    | through 2k $\Omega$ re | sistors        |             |  |
| Bit 2, 1, 0 | CMI_ADJ_2_A, C   | MI_ADJ_1_A,   | CMI_ADJ_0_A    | : CHA input co   | mmon-mode a            | djustment      |             |  |
|             | 000 = 0.900V (de   | efault)       |                |                  |                        |                |             |  |
|             | 001 = 1.050V   |               |                |                  |                        |                |             |  |
|             | 010 = 1.200V   |               |                |                  |                        |                |             |  |
|             | 011 = 1.350V   |               |                |                  |                        |                |             |  |
|             | 100 = 0.900 V  |               |                |                  |                        |                |             |  |
|             | 101 = 0.750V   |               |                |                  |                        |                |             |  |
|             | 110 = 0.600V   |               |                |                  |                        |                |             |  |
|             | 111 = 0.450V   |               |                |                  |                        |                |             |  |

### Software Reset (0Ah)

Bit 7–0 SWRESET: Write 5Ah to initiate software reset

#### **Clock Inputs**

The input clock interface provides for flexibility in the requirements of the clock driver. The MAX19505 accepts a fully differential clock or single-ended logiclevel clock. For differential clock operation, connect a differential clock to the CLK+ and CLK- inputs. In this mode, the input common mode is established internally to allow for AC-coupling. The differential clock signal can also be DC-coupled if the common mode is constrained to the specified 1V to 1.4V clock input common-mode range. For single-ended operation, connect CLK- to GND and drive the CLK+ input with a logiclevel signal. When the CLK- input is grounded (or pulled below the threshold of the clock mode detection comparator) the differential-to-single-ended conversion stage is disabled and the logic-level inverter path is activated.

#### **Clock Divider**

The MAX19505 offers a clock-divider option. Enable clock division either by setting DIV0 and DIV1 through the serial interface; see the Clock Divide/Data



**DUAL-BUS OUTPUT MODE** SAMPLING INSTANT SAMPLING SAMPLING SAMPLING INSTANT INSTANT INSTANT t<sub>AD</sub> SAMPLING SAMPLING INSTANT INSTANT IN tCLF SAMPLE ON RISING EDGE tсн n+2 n+3 n+5 n+1 n+4 SAMPLE CLOCK – t<sub>DD</sub> DATA, DOR n-10 n-9 n-8 n-7 n-6 n-5 n-4 t<sub>HOLD</sub> t<sub>DC</sub> tsetup -DCLK SAMPLE CLOCK IS THE DERIVED CLOCK FROM (CLK+ - CLK-)/CLOCK DIVIDER, IN\_ = IN\_+ - IN\_-

Figure 8. Simplified Clock Input Schematic

Figure 9. Dual-Bus Output Mode Timing



Figure 10. Multiplexed Output Mode Timing

Format/Test Pattern register (06h) for clock-divider options, or in parallel programming configuration (SPEN = 1) by using the DIV input.

#### System Timing Requirements

Figures 9 and 10 depict the relationship between the clock input and output, analog input, sampling event, and data output. The MAX19505 samples on the rising edge of the sampling clock. Output data is valid on the next rising edge of DCLK after a nine-clock internal latency. For applications where the clock is divided, the sample clock is the divided internal clock derived from:

[(CLK+ - CLK-)/DIVIDER]

#### Synchronization

When using the clock divider, the phase of the internal clock can be different than that of the FPGA, microcontroller, or other MAX19505s in the system. There are

two mechanisms to synchronize the internal clock: slip synchronization and edge synchronization. Select the synchronization mode using SYNC\_MODE (bit 2) in the Clock Divide/Data Format/Test Pattern register (06h) and drive the SYNC input high to synchronize.

Slip Synchronization Mode, SYNC\_MODE = 0 (default): On the third rising edge of the input clock (CLK) after the rising edge of SYNC (provided set-up and hold times are met), the divided output is forced to skip a state transition (Figure 11).

**Edge Synchronization Mode, SYNC\_MODE = 1:** On the third rising edge of the input clock (CLK) after the rising edge of SYNC (provided set-up and hold times are met), the divided output is forced to state 0. A divided clock rising edge occurs on the fourth (/2 mode) or fifth (/4 mode) rising edge of CLK, after a valid rising edge of SYNC (Figure 12).

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Figure 11. Slip Synchronization Mode



Figure 12. Edge Synchronization Mode

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| •                   |   |
|---------------------|---|
| DATA TIMING CONTROL | DESCRIPTION   |
| DA_BYPASS           | Data aligner bypass. When this control is active (high), data and DCLK delay is reduced by approximately 3.4ns (relative to DA_BYPASS = 0).   |
| DLY_HALF_T          | When this control is active, data output is delayed by half clock period (T/2). This control does not delay data output if MUX mode is active.  |
| DTIME<2:0>          | Allows adjustment of data output delay in T/16 increments, where T is the sample clock period.  |
| DCLKTIME<2:0>       | Provides adjustment of DCLK delay in T/16 increments, where T is the sample clock period. When DTIME and DCLKTIME are adjusted to the same setting, the rising edge of DCLK occurs T/8 prior to data transitions. |

### **Table 4. Data Timing Controls**

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# Table 5. Data Timing Control DefaultSettings

| DATA TIMING<br>CONTROL | DEFAULT | DESCRIPTION           |
|------------------------|---------|-----------------------|
| DA_BYPASS              | 1       | Data aligner disabled |
| DLY_HALF_T             | 0       | No delay              |
| DTIME<2:0>             | 000     | No delay              |
| DCLKTIME<2:0>          | 000     | No delay              |

#### **Digital Outputs**

The MAX19505 features a dual CMOS, multiplexable, reversible data bus. In parallel programming mode, configure the data outputs (D0\_-D7\_) for offset binary, two's complement, or gray code using the FORMAT input. Select multiplexed or dual-bus operation using the OUTSEL input. See the Output Format register (01h) for details on output formatting using the SPI interface. The SPI interface offers additional flexibility where D0\_-D7\_ are reversed, so the LSB appears at D7\_ and the MSB at D0\_. OVDD sets the output voltage; set OVDD between 1.8V and 3.3V. The digital outputs feature programmable output impedance from  $50\Omega$  to  $300\Omega$ . Set the output impedance for each bus using the CH\_ Data Output Termination Control registers (04h and 05h).

#### Programmable Data Timing

The MAX19505 provides programmable data timing control to allow for optimization of timing characteristics to meet the system timing requirements. The timing adjustment feature also allows for ADC performance improvements by shifting the data output transition away from the sampling instant. The data timing control signals are summarized in Table 4. The default settings for timing adjustment controls are given in Table 5. Many applications do not require adjustment from the default settings.

The effects of the data timing adjustment settings are illustrated in Figures 13 and 14. The x axis is sampling rate and the y axis is data delay in units of clock period.

The solid lines are the nominal data timing characteristics for the 14 available states of DTIME and DLY\_HALF\_T. The heavy line represents the nominal data timing characteristics for the default settings. Note that the default timing adjustment setting for the MAX19505 65Msps ADC results in an additional period of data latency.

Tables 6 and 7 show the recommended timing control settings versus sampling rate.

The nominal data timing characteristics versus sampling rate for these recommended timing adjustment settings are shown in Figures 15 and 16.

When DA\_BYPASS = 1, the DCLKTIME delay setting must be equal to or less than the DTIME delay setting, as shown in Table 8.

#### **Power Management**

The SHDN input (pin 7) toggles between any two powermanagement states. The Power Management register (00h) defines each power-management state. In default state, SHDN = 1 shuts down the MAX19505 and SHDN = 0 returns to full power. Use of the SHDN input is not required for power management. For either state of SHDN, complete power-management flexibility is provided, including individual ADC channel power-management control, through the Power Management register (00h). The available reduced-power modes are shutdown and standby. In standby mode, the reference and duty-cycle equalizer circuits remain active for rapid wake-up time. In standby mode, the externally applied clock signal must remain active for the duty-cycle equalizer to remain locked. Typical wake-up time from standby mode is 15µs. In shutdown mode, all circuits are turned off except for the reference circuit required for the integrated self-sensing voltage regulator. If the regulator is active, there is additional supply current associated with the regulator circuit when the device is in shutdown. Typical wake-up time from shutdown mode is 5ms, which is dominated by the RC time constant on REFIO.



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Figure 13. Default Data Timing (VOVDD = 1.8V)



Figure 14. Default Data Timing (V<sub>OVDD</sub> = 3.3V)







Figure 16. Recommended Data Timing (V<sub>OVDD</sub> = 3.3V)

### Table 6. Recommended Timing Adjustments (V<sub>OVDD</sub> = 1.8V)

| SAMPLING RATE (Msps) |    | V <sub>OVDD</sub> = 1.8V |            |            |               |
|----------------------|----|--------------------------|------------|------------|---------------|
| FROM                 | то | DA_BYPASS                | DLY_HALF_T | DTIME<2:0> | DCLKTIME<2:0> |
| 30                   | 56 | 1                        | 0          | 000        | 000           |
| 56                   | 65 | 1                        | 0          | 101        | 101           |

### Table 7. Recommended Timing Adjustments (V<sub>OVDD</sub> = 3.3V)

| SAMPLING | RATE (Msps) | V <sub>OVDD</sub> = 3.3V |            |            |               |
|----------|-------------|--------------------------|------------|------------|---------------|
| FROM     | то          | DA_BYPASS                | DLY_HALF_T | DTIME<2:0> | DCLKTIME<2:0> |
| 30       | 65          | 1                        | 0          | 000        | 000           |

### Table 8. Allowed Settings of DCLKTIME and DTIME for DA\_BYPASS = 1

| DTIME<2:0>    | ALLOWED DCLKTIME<2:0> SETTINGS  |
|---------------|---|
| 111 (-3T/16)  | 111 (-3T/16)  |
| 110 (-2T/16)  | 110 (-2T/16); 111 (-3T/16)  |
| 101 (-1T/16)  | 101 (-1T/16); 110 (-2T/16); 111 (-3T/16)  |
| 000 (nominal) | 000 (nominal); 101 (-1T/16); 110 (-2T/16); 111 (-3T/16)   |
| 001 (+1T/16)  | 001 (+1T/16); 000 (nominal); 101 (-1T/16); 110 (-2T/16); 111 (-3T/16)                             |
| 010 (+2T/16)  | 010 (+2T/16); 001 (+1T/16); 000 (nominal); 101 (-1T/16); 110 (-2T/16); 111 (-3T/16)               |
| 011 (+3T/16)  | 011 (+3T/16); 010 (+2T/16); 001 (+1T/16); 000 (nominal); 101 (-1T/16); 110 (-2T/16); 111 (-3T/16) |

### Table 9. Reset Methods

| RESET MODE     | DESCRIPTION  |
|----------------|--|
| Power-On Reset | Upon power-up (AVDD supply voltage and clock signal applied), the POR (power-on-reset) circuit initiates a register reset. |
| Software Reset | Write data 5Ah to address 0Ah to initiate register reset.  |
| Hardware Reset | A register reset is initiated by the falling edge on the SHDN pin when SPEN is high.                                       |

#### **Integrated Voltage Regulator**

The MAX19505 includes an integrated self-sensing linear voltage regulator on the analog supply (AVDD). See Figure 17. When the applied voltage on AVDD is below 2V, the voltage regulator is bypassed, and the core analog circuitry operates from the externally applied voltage. If the applied voltage on AVDD is higher than 2V, the regulator bypass switches off, and voltage regulator mode is enabled. When in voltage regulation mode, the internal-core analog circuitry operates from a stable 1.8V supply voltage provided by the regulator. The regulator provides an output voltage of 1.8V over a 2.3V to 3.5V AVDD input-voltage range. Since the power-supply current is constant over this voltage range, analog power dissipation is proportional to the applied voltage.

#### **Power-On and Reset**

The user-programmable register default settings and other factory-programmed settings are stored in nonvolatile memory. Upon device power-up, these values are loaded into the control registers. This operation occurs after application of supply voltage to AVDD and application of an input clock signal. The register values are retained as long as AVDD is applied. While AVDD is applied, the registers can be reset, which overwrites all user-programmed registers with the default values. This reset operation can be initiated by software command through the serial-port interface or by hardware control using the SPEN and SHDN inputs. The reset time is proportional to the ADC clock period and requires 130µs at 65Msps. Table 9 summarizes the reset methods.



Figure 17. Integrated Voltage Regulator



Figure 18. Transformer-Coupled Input Drive for Input Frequencies Up to Nyquist

### Applications Information

#### **Analog Inputs**

#### Transformer-Coupled Differential Analog Input

The MAX19505 provides better SFDR and THD with fully differential input signals than a single-ended input drive. In differential input mode, even-order harmonics are lower as both inputs are balanced, and each of the ADC inputs only require half the signal swing compared to single-ended input mode.

An RF transformer (Figure 18) provides an excellent solution for converting a single-ended signal to a fully differential signal. Connecting the center tap of the transformer to CM\_ provides a common-mode voltage. The transformer shown has an impedance ratio of 1:1.4. Alternatively, a different step-up transformer can be selected to reduce the drive requirements. A reduced signal swing from the input driver can also improve the overall distortion. The configuration of Figure 18 is good for frequencies up to Nyquist ( $f_{CLK}/2$ ).



Figure 19. Transformer-Coupled Input Drive for Input Frequencies Beyond Nyquist

#### 



Figure 20. Single-Ended, AC-Coupled Input Drive

The circuit of Figure 19 also converts a single-ended input signal to a fully differential signal. Figure 19 utilizes an additional transformer to improve the commonmode rejection, allowing high-frequency signals beyond the Nyquist frequency. A set of  $75\Omega$  and  $110\Omega$  termination resistors provide an equivalent  $50\Omega$  termination to the signal source. The second set of termination resistors connect to CM\_ providing the correct input common-mode voltage.

#### Single-Ended AC-Coupled Input Signal

Figure 20 shows a single-ended, AC-coupled input application. The MAX4108 provides high speed, high bandwidth, low noise, and low distortion to maintain the input signal integrity. Bias voltage is applied to the inputs through internal  $2k\Omega$  resistors. See Common Mode register 08h for further details.

#### **DC-Coupled Input**

The MAX19505's wide common-mode voltage range (0.4V to 1.4V) allows DC-coupled signals. Ensure that the common-mode voltage remains between 0.4V and 1.4V.

#### **Clock Input**

Figure 21 shows a single-ended-to-differential clock input converting circuit.

### Grounding, Bypassing, and Board-Layout Considerations

The MAX19505 requires high-speed board-layout design techniques. Locate all bypass capacitors as close as possible to the device, preferably on the same side as the ADC, using surface-mount devices for minimum inductance. Bypass AVDD, OVDD, REFIO, CMA, and CMB with  $0.1\mu$ F ceramic capacitors to GND. Multilayer boards with ground and power planes



Figure 21. Single-Ended-to-Differential Clock Input

produce the highest level of signal integrity. Route highspeed digital signal traces away from the sensitive analog traces of either channel. Make sure to isolate the analog input lines to each respective converter to minimize channel-to-channel crosstalk. Keep all signal lines short and free of 90° turns.

### Definitions

#### **Integral Nonlinearity (INL)**

INL is the deviation of the measured transfer function from a best-fit straight line. Worst-case deviation is defined as INL.

#### **Differential Nonlinearity (DNL)**

DNL is the difference between the measured transfer function step width and the ideal value of 1 LSB. A DNL error specification of less than 1 LSB guarantees no missing codes and a monotonic transfer function. DNL deviations are measured at each step of the transfer function and the worst-case deviation is defined as DNL.

#### **Offset Error**

Offset error is a parameter that indicates how well the actual transfer function matches the ideal transfer function at midscale. Ideally, the midscale transition occurs at 0.5 LSB above midscale. The offset error is the amount of deviation between the measured midscale transition point and the ideal midscale transition point.

#### **Gain Error**

Gain error is a figure of merit that indicates how well the slope of the measured transfer function matches the slope of the ideal transfer function based on the specified full-scale input-voltage range. The gain error is defined as the relative error of the measured transfer function and is expressed as a percentage.



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#### Small-Signal Noise Floor (SSNF)

SSNF is the integrated noise and distortion power in the Nyquist band for small-signal inputs. The DC offset is excluded from this noise calculation. For this converter, a small signal is defined as a single tone with an amplitude less than -35dBFS. This parameter captures the thermal and quantization noise characteristics of the converter and can be used to help calculate the overall noise figure of a receive channel. Refer to **www.maxim-ic.com** for application notes on Thermal + Quantization Noise Floor.

#### Signal-to-Noise Ratio (SNR)

For a waveform perfectly reconstructed from digital samples, the theoretical maximum SNR is the ratio of the full-scale analog input (RMS value) to the RMS quantization error (residual error). The ideal, theoretical minimum analog-to-digital noise is caused by quantization error only and results directly from the ADC's resolution (N bits):

$$SNR[max] = 6.02 \times N + 1.76$$

In reality, there are other noise sources besides quantization noise (e.g., thermal noise, reference noise, clock jitter, etc.). SNR is computed by taking the ratio of the RMS signal to the RMS noise. RMS noise includes all spectral components to the Nyquist frequency excluding the fundamental, the first six harmonics (HD2–HD7), and the DC offset.

$$SNR = 20 \times \log\left(\frac{SIGNAL_{RMS}}{NOISE_{RMS}}\right)$$

#### Signal-to-Noise and Distortion (SINAD)

SINAD is computed by taking the ratio of the RMS signal to the RMS noise plus the RMS distortion. RMS noise includes all spectral components to the Nyquist frequency excluding the fundamental, the first six harmonics (HD2–HD7), and the DC offset. RMS distortion includes the first six harmonics (HD2–HD7).

$$SINAD = 20 \times \log \left( \frac{SIGNAL_{RMS}}{\sqrt{NOISE_{RMS}^2 + DISTORTION_{RMS}^2}} \right)$$

#### Single-Tone Spurious-Free Dynamic Range (SFDR1 and SFDR2)

SFDR is the ratio expressed in decibels of the RMS amplitude of the fundamental (maximum signal component) to the RMS amplitude of the next largest spurious component, excluding DC offset. SFDR1 reflects the spurious performance based on worst 2nd-order or 3rd-order harmonic distortion. SFDR2 is defined by the worst spurious component excluding 2nd- and 3rd-order harmonics and DC offset.

#### **Total Harmonic Distortion (THD)**

THD is the ratio of the RMS of the first six harmonics of the input signal to the fundamental itself. This is expressed as:

THD = 
$$20 \times \log \left( \frac{\sqrt{V_2^2 + V_3^2 + V_4^2 + V_5^2 + V_6^2 + V_7^2}}{V_1} \right)$$

where V<sub>1</sub> is the fundamental amplitude and V<sub>2</sub>–V<sub>7</sub> are the amplitudes of the 2nd-order through 7th-order harmonics (HD2–HD7).

#### **Third-Order Intermodulation (IM3)**

IM3 is the total power of the third-order intermodulation products to the Nyquist frequency relative to the total input power of the two input tones f<sub>IN1</sub> and f<sub>IN2</sub>. The individual input tone levels are at -7dBFS. The third-order intermodulation products are:  $2 \times f_{IN1} - f_{IN2}$ ,  $2 \times f_{IN2} - f_{IN1}$ ,  $2 \times f_{IN1} + f_{IN2}$ ,  $2 \times f_{IN2} + f_{IN1}$ .

#### **Aperture Delay**

The input signal is sampled on the rising edge of the sampling clock. There is a small delay between the rising edge of the sampling clock and the actual sampling instant, which is defined as aperture delay (t<sub>AD</sub>).

#### **Aperture Jitter**

Aperture jitter (t<sub>AJ</sub>) is defined as the sample-to-sample time variation in the aperture delay.

#### **Overdrive Recovery Time**

Overdrive recovery time is the time required for the ADC to recover from an input transient that exceeds the full-scale limits. The specified overdrive recovery time is measured with an input transient that exceeds the full-scale limits by  $\pm 10\%$ .

#### Chip Information

PROCESS: CMOS



### **Package Information**

For the latest package outline information and land patterns, go to **www.maxim-ic.com/packages**. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE TYPE | PACKAGE CODE | OUTLINE NO.    | LAND PATTERN NO. |
|--------------|--------------|----------------|------------------|
| 48 TQFN-EP   | T4877+4      | <u>21-0144</u> | <u>90-0130</u>   |

### **Revision History**

| REVISION<br>NUMBER | REVISION<br>DATE | DESCRIPTION  | PAGES<br>CHANGED |
|--------------------|------------------|--|------------------|
| 0                  | 10/08            | Initial release  | —                |
| 1                  | 9/10             | Updated timing characteristics based on CMOS output driver changes | 5, 6, 28, 29, 30 |

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- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком):

- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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